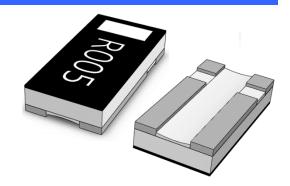
RL1632T4F Series Current Sensor Resistor (Lead / Halogen Free)

Features / Applications:

- Power rating is up to 1W
- Low TCR current sensor
- Low thermal EMF (< 3 µV/°C)
- Resistors are ideal for all types of current sensing
- Metal foil construction; Excellent long-term stability
- Moisture sensitivity level: MSL 1
- RoHS compliant



Electrical Specifications:

Characteristics ¹ Feature				
Power Rating ²	1 W			
Resistance Value(mΩ)	0.5 \ 0.75	1 \ 1.5	2 to 4	5 to 9
Temperature Coefficient of Resistance(ppm/°C)	± 300	± 150	± 100	± 50
Operation Temperature Range	-55°C to +150°C			
Maximum Working Voltage (V)	(P*R) ^{1/2}			

Note:

- 1. For detailed information see table on page 3
- 2. For sensors operated at ambient temperature in excess of 70°C, the maximum load shall be derated in accordance with the following curve.

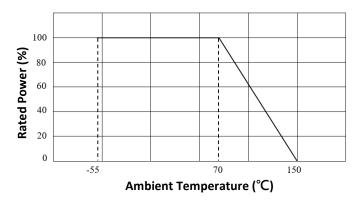


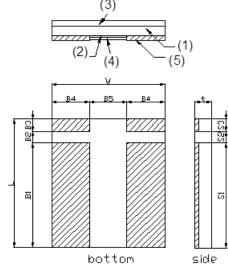
Figure 1. : Power Temperature Derating Curve

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Outline Drawing:





- (1) Substrate
- (2) Resistor: Cu alloy
- (3) Protection coat:

Heat resistive epoxy resin (Black)

(4) Protection coat:

Heat resistive epoxy resin (White)

(5) Terminals: Sn (on Cu)

Resistance Range(mΩ)	L	w	S1	S2	S3	t
< 2	2 20+0 15	3.20±0.15	2 2010 20 0 5010	0.50±0.20	240 20 0 5040 20	0.70±0.20
≧2	3.2U±U.15		0.50±0.20	0.50±0.20	0.60±0.20	
0.5 to 0	B1	B2	В3	В4	В5	
0.5 to 9	2.20±0.20	0.50±0.20	0.50±0.20	0.45±0.20	0.70±0.20	

(Unit:mm)

Type Designation:

(1) (2) (3) (4)

Note:

(1) Series No.

(2) Size(T4F = 4 - terminal)

(3) Resistance value : $0R5m = 0.5m\Omega$; $R002 = 2m\Omega$; $R010 = 10m\Omega$

(4) Tolerance: $\pm 0.5\%(D)$, $\pm 1\%(F)$, $\pm 2\%(G)$

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Available standard resistance values:

Resistance	Tolerance			
Values	±0.5%	±1.0%	±2.0%	
0R5m		✓	✓	
0R75m		✓	✓	
R001		✓	✓	
1R5m		✓	✓	
R002	✓	✓	✓	
2R5m		✓	✓	
R003	✓	✓	✓	
R004		✓	✓	
R005	✓	✓	✓	
R006		✓	✓	
R007	✓	✓	✓	
R008		✓	✓	
R009	✓	✓	✓	

^{✓ =} available

Further values and tolerances on request.

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Reliability Performance:

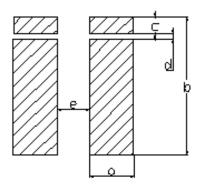
Test Item	Condition of Test	Requirements
Short Time Overload	2.5 x Rated power for 5 seconds Refer to JIS C 5201-1 4.13	ΔR: ± 1.0%
Thermal Shock	-55 to 125℃ 100 cycles, 15 min at each extreme condition Refer to JIS C 5201-1 4.19	ΔR: ± 1.0%
Low Temperature Storage	Kept at -55℃, 1000 hours Refer to JIS C 5201-1 4.23.4	ΔR: ± 2.0%
Resistance to Soldering Heat	Dipped into solder at $270 \pm 5^{\circ}$ C for 10 ± 1 seconds Refer to JIS C 5201-1 4.18	ΔR: ± 1.0%
Load Life	Rated voltage for 1.5hours followed by a pause 0.5hour at 70 ± 3°C Cycle repeated 1000 hours Refer to JIS C 5201-1 4.25	ΔR: ± 2.0%
Damp Heat with Load	$40 \pm 2^{\circ}$ C with relative humidity 90% to 95%. D.C. rated voltage for 1.5 hours ON and 30 minutes OFF. Cycle repeated 1000 hours Refer to JIS C 5201-1 4.24	ΔR : ± 2.0%
High Temperature Exposure	Kept at 150°C for 1000 hours Refer to JIS C 5201-1 4.23.2	ΔR: ± 2.0%
Solderability	Temperature of Solder : 245 ± 5 $^{\circ}$ C Immersion Duration : 3 ± 0.5 second Refer to JIS C 5201-1 4.17	Uniform coating of solder cover minimum of 95% surface being immersed
Mechanical Shock	100 G's for 6milliseconds. 5 pulses Refer to JIS C 5201-1 4.21	ΔR: ± 0.5%
Substrate Bending	Glass-Epoxy board thickness : 1.6mm Bending width : 2mm Between the fulcrums : 90mm Refer to JIS C 5201-1 4.33	ΔR : ± 0.5%

Note: Measurement at 24±4 hours after test conclusion for all reliability tests-parts.

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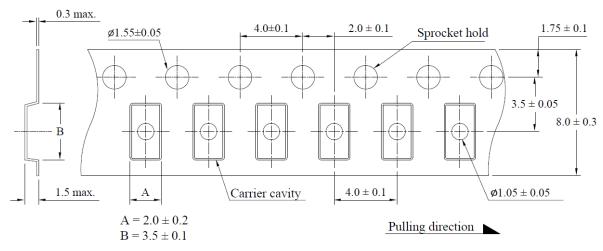
Recommend Solder Pad Dimensions:



Dimensions (mm)	а	b	С	d	е
0.5 to 9 m Ω	1.0	3.5	0.8	0.38	0.75

Packaging:

Tape packaging dimensions:



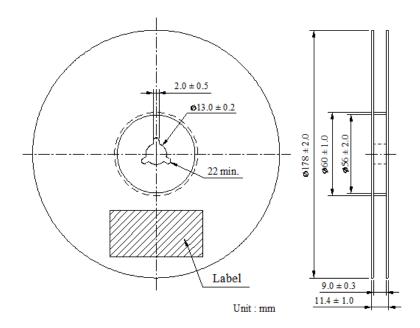
Unit: mm

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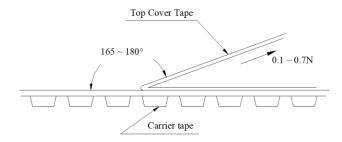
Reel dimensions:



Peel Strength of Top Cover Tape:

The peel speed shall be about 300mm/min.

The peel force of top cover tape shall between 0.1 to 0.7N



Number of Taping:

4,000 pieces / reel

Label Marking:

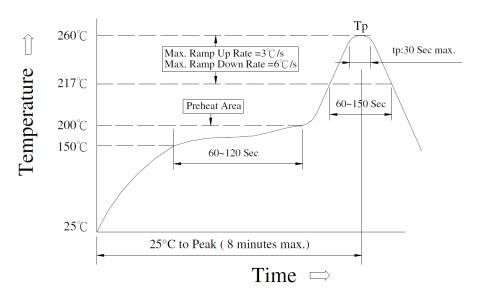
The following items shall be marked on the reel.

- (1) Type designation
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name
- (5) The country of origin

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Recommend Soldering Conditions:



Meet JEDEC-020D

(1) Reflow Soldering Method:

Defless Calderine	Tp:255 to 260℃ Max.30 seconds (Tp)		
Reflow Soldering	217℃ 60 to 150 seconds		
Pre-Heat	150 to 200℃ 60 to 120 seconds		
Time 25℃ to peak temperature	8 minutes max		

(2) Soldering Iron Method: 350± 5°C max.3 seconds

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Care Note:

Care note for storage

- (1) Current sensor shall be stored in a environment where temperature and humidity must be controlled (temperature 5 to 40°C, humidity 30 to 80% RH). However, the humidity should be maintained as low as possible.
- (2) Current sensor shall not be stored under direct sunlight.
- (3) Current sensor shall be stored in condition without moisture, dust, any material defect solderability, or hazardous gas (i.e. Chlorination hydrogen, sulfurous acid gas, and sulfuration hydrogen)
- (4) The sensor can be stored for at least one year under the condition mentioned above.

Care note for operating and handling

- (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
- (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
- (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.

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